

Complementary MOSFET Half-Bridge (N- and P-Channel)

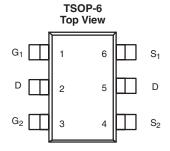
PRODUCT SUMMARY				
	V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	
N-Channel	20	0.300 at V _{GS} = 4.5 V	1.4	
		0.410 at V _{GS} = 3.0 V	1.2	
P-Channel	- 20	0.640 at V _{GS} = - 4.5 V	- 0.96	
		0.980 at V _{GS} = - 3.0 V	- 0.78	

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R_a Tested
- Compliant to RoHS Directive 2002/95/EC

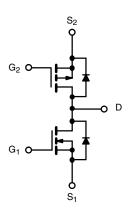






Ordering Information: Si3850ADV-T1-E3 (Lead (Pb)-free)

Si3850ADV-T1-GE3 (Lead (Pb)-free and Halogen-free)



ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted						
Parameter		Symbol	N-Channel	P-Channel	Unit	
Drain-Source Voltage		V_{DS}	20	- 20	V	
Gate-Source Voltage		V _{GS}	±	7 V		
Continuous Drain Current (T _{.1} = 150 °C)	T _A = 25 °C	. I _D	1.4	- 0.96		
Continuous Diam Current (1) = 150 C)	T _A = 70 °C		1.1	- 0.77	A	
Pulsed Drain Current		I _{DM}	3.5	- 2.0	7	
Continuous Source Current (Diode Conduction) ^a		I _S	0.9	- 0.9		
Maximum Power Dissipation	T _A = 25 °C	P _D	1.08 0.70		W	
(Surface Mounted on FR4 Board)	T _A = 70 °C	' D				
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150			

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	N- or P-Channel	Unit		
Maximum Junction-to-Ambient (Surface Mounted on FR4 Board, ± ≤ 10 s)	R _{thJA}	115	°C/W		

Note:

Maximum under Steady State condition is 150 °C/W.



D	O	ss otherwise noted	ı	B.4.*	T		11	
Parameter	Symbol	Test Conditions		Min.	Тур.	Max.	Unit	
Static	I	V V I 050A	N 01		l	4 -		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	N-Ch	0.6		1.5	V	
		$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	P-Ch	- 0.6		- 1.5		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$				± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	N-Ch			1	- μΑ	
		$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$	P-Ch			- 1		
		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$	N-Ch			10		
		$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$	P-Ch			- 10		
On-State Drain Current ^b	l	$V_{DS} = 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	N-Ch	3.0			^	
	I _{D(on)}	$V_{DS} = -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	P-Ch	- 1.5			Α	
		V _{GS} = 4.5 V, I _D = 0.5 A	N-Ch		0.240	0.300	Ω	
	Ь	V _{GS} = - 4.5 V, I _D = - 0.5 A	P-Ch		0.510	0.640		
Drain-Source On-State Resistance ^b	R _{DS(on)}	$V_{GS} = 3.0 \text{ V}, I_D = 0.5 \text{ A}$	N-Ch		0.325	0.410		
		V _{GS} = - 3.0 V, I _D = - 0.5 A	P-Ch		0.780	0.980		
L	9 _{fs}	V _{DS} = 10 V, I _D = 1 A	N-Ch		1.8		S	
Forward Transconductance ^b		V _{DS} = - 10 V, I _D = - 1 A	P-Ch		1.1			
	V _{SD}	I _S = 0.9 A, V _{GS} = 0 V	N-Ch		0.87	1.2	V	
Diode Forward Voltage ^b		I _S = - 0.8 A, V _{GS} = 0 V	P-Ch		- 1.0	- 1.3		
Dynamic ^b			l l					
•			N-Ch		0.95	1.4		
Total Gate Charge	Q_g	N-Channel	P-Ch		1.10	1.7		
Cata Causa Chassa	Q _{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 1 \text{ A}$	N-Ch		0.22		nC	
Gate-Source Charge		P-Channel	P-Ch		0.28			
Gate-Drain Charge	Q_{gd}	V _{DS} = - 10 V, V _{GS} = - 4.5 V, I _D = - 1 A	N-Ch		0.24			
date Brain Griange	Gga		P-Ch		0.26			
Gate Resistance	R_{g}		N-Ch		3.5	5.3	Ω	
	9		P-Ch		10.5	16		
Turn-On Delay Time	t _{d(on)}	N-Channel	N-Ch		8	14		
	4(0)	$V_{DD} = 10 \text{ V}, R_L = 10 \Omega$ $I_D \approx 0.9 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_q = 1 \Omega$	P-Ch		13	20		
Rise Time	t _r		N-Ch P-Ch		16	25		
		Ç	N-Ch		34 20	50 30		
Turn-Off Delay Time	t _{d(off)}	P-Channel	P-Ch		18	30	ns	
	t _f I _D ≅	$V_{DD} = -10 \text{ V}, R_L = 10 \Omega$ $I_D \cong -0.9 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	N-Ch		9	15		
Fall Time		1D = -0.3 A, VGEN = -4.3 V, ng = 1.22	P-Ch		18	30		
		I _F = 0.9 A, dl/dt = 100 A/μs	N-Ch		20	30		
Body Diode Reverse Recovery Tme	t _{rr}	I _F = - 0.9 A, dl/dt = 100 A/μs						
Body Diode Reverse Recovery Charge	Q _{rr}	$I_F = 0.9 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$	N-Ch		9	15		
		οιο / ι, αι/αι - 100 / νμο	IN OII		ı	13	nC	

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Guaranteed by design, not subject to production testing.

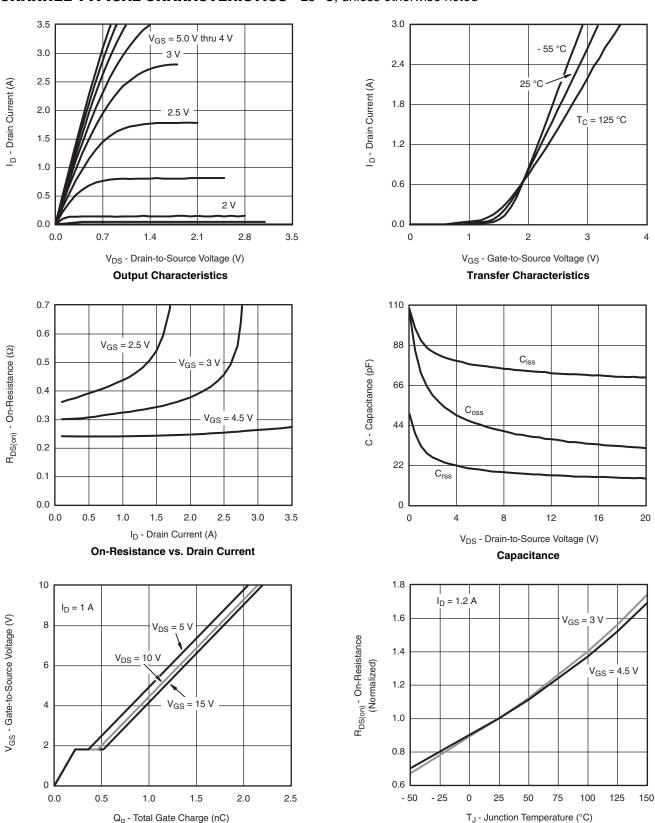
b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.







N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

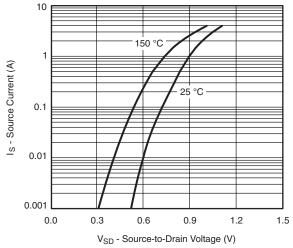


Gate Charge

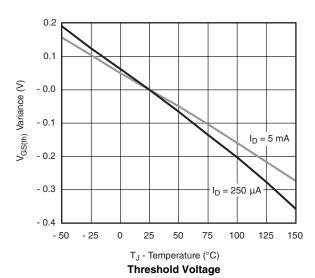
On-Resistance vs. Junction Temperature

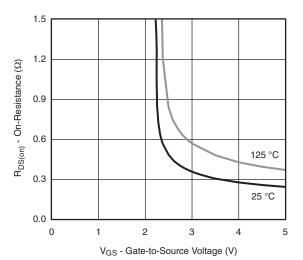
VISHAY

N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

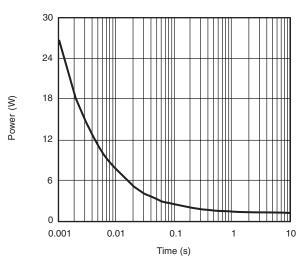


Source-Drain Diode Forward Voltage

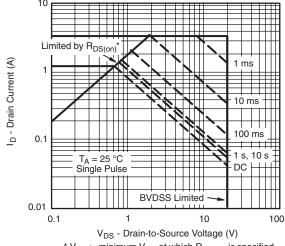




On-Resistance vs. Gate-to-Source Voltage



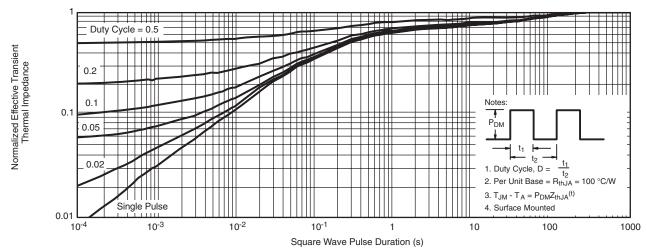
Single Pulse Power



* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area

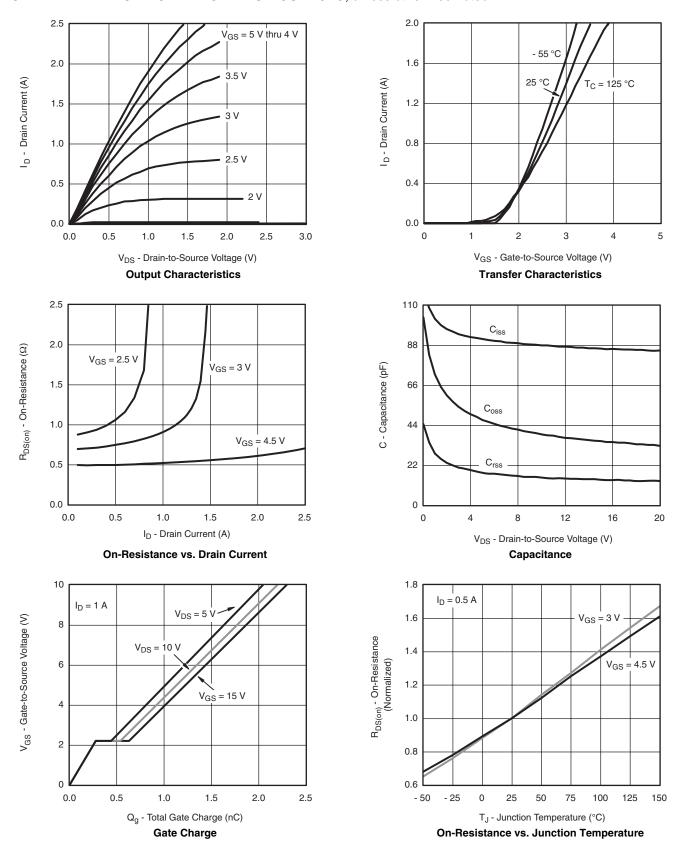
N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient

VISHAY

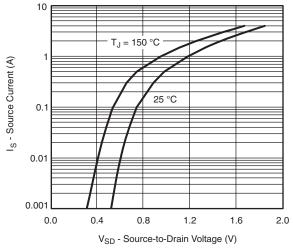
P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



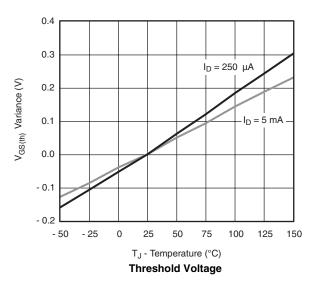


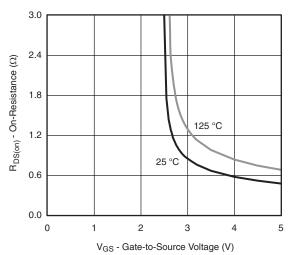


P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

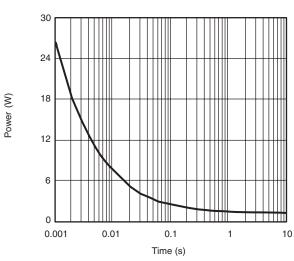


Source-Drain Diode Forward Voltage

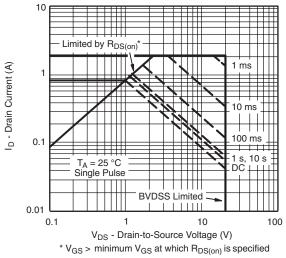




On-Resistance vs. Gate-to-Source Voltage



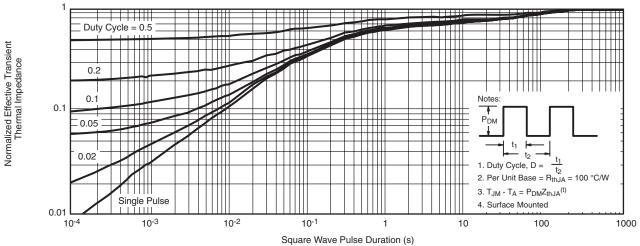
Single Pulse Power vs. Junction-to-Ambient



Safe Operating Area



P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient

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